

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SI CHEN	11/05/2020
ZHENHUA LIU	11/05/2020
RECEIVING PARTY DATA	
Name:	IFORY LIMITED
Street Address:	ROOM 1449, 14/F., SUI FAI FACTORY ESTATE,
Internal Address:	5-13 SHAN MEI STREET, FOTAN, NEW TERRITORIES
City:	HONG KONG
State/Country:	CHINA
Postal Code:	999077
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17096604
CORRESPONDENCE DATA	
Fax Number:	(703)205-8050
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	7032058000
Email:	Lynn.T.Lam@bskb.com, mailroom@bskb.com
Correspondent Name:	BIRCH STEWART KOLASCH & BIRCH LLP
Address Line 1:	8110 GATEHOUSE ROAD, SUITE 100 EAST
Address Line 4:	FALLS CHURCH, VIRGINIA 22042
ATTORNEY DOCKET NUMBER:	6555-0129PUS1
NAME OF SUBMITTER:	LYNN LAM
SIGNATURE:	/lynn lam/
DATE SIGNED:	11/13/2020
Total Attachments: 1	
source=2020-11-13_Declaration_and_Assignment_6555-0129PUS1#page1.tif	

COMBINED DECLARATION & ASSIGNMENT

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Title: BONE CONDUCTION EARPHONE

ASSIGNMENT

WHEREAS, we, CHEN, Si and LIU, Zhenhua have invented certain new and useful improvements as described in U.S. patent application, entitled **BONE CONDUCTION EARPHONE**, the application having been executed on even date herewith, and/or being identified in the United States Patent and Trademark Office ("USPTO") by Application No. _____, filed _____, ("Invention"); and

WHEREAS, Hory Limited, a Corporation of the People's Republic of China, and having an address of Room 1449, 14/F., Sai Fai Factory Estate, 5-13 Shan Mei Street, Fotan, New Territories, Hong Kong 999077, the People's Republic of China (together with its successors and assigns, the "Assignee"), seeks to memorialize its ownership of the entire right, title and interest in and to the Invention;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt and adequacy of which are hereby acknowledged, I transfer to Assignee my entire right, title, and interest in and to the Invention, including all inventions disclosed or claimed in the above-identified patent application, including any improvements thereof, any corresponding domestic applications (e.g., provisional, non-provisional, divisional, continuation, continuation-in-part, reexamination, and/or reissue patent), any corresponding foreign applications, all patents issuing thereon, or other patent application based off or claiming priority to the above-identified patent application, and all rights and benefits under any applicable treaty or convention. I authorize the USPTO (or foreign equivalent thereof) to issue any patent (or similar legal protection) to the Assignee.

I authorize the Assignee to insert in this instrument the filing date and application number of the application when ascertained. I hereby authorize the Assignee (or its designee) to apply for patent (or similar legal protection) in its own name if desired, in any and all countries.

I represent to the Assignee that I have not and shall not execute any writing or do any act whatsoever conflicting with this Assignment. I agree when requested, without additional consideration, but at the expense of the Assignee, to provide additional reasonable assistance necessary to memorialize this assignment, to execute all oaths, declarations, assignments, powers of attorney and other papers necessary to perfect and vest title to the rights assigned herein to the Assignee; and will render all assistance in filing, obtaining, maintaining, and enforcing any patent (or similar legal protection) on the Invention in any and all countries.

DECLARATION

I have reviewed and understand the contents of the above-identified patent application including the claims, and I believe I am an original or an original joint inventor of a claimed invention in the above-identified patent application. The above-identified patent application was made or authorized to be made by me. I am aware of and acknowledge my duty to disclose to the USPTO all information known to me to be material to patentability of the claims in the above-identified patent application. I acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

CHEN, Si

CHEN, Si

Date 2020.11.05

LIU, Zhenhua

LIU, Zhenhua

Date 2020.11.5

PATENT

RECORDED: 11/13/2020

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